Enable IC breakthroughs

with MKS Instruments surrounding chambers 万机仪器助力中国IC产业做强做大



Mar, 2017



China IC Development

Roadmap issued on Jun 24, 2014

	2015	2020
Revenue	>RMB 350B	>RMB 870B (CAGR>20%)
Manufactu ring Node	32/28nm mass production	16/14nm mass production
Design	Advanced or closer technology in focused technical areas (such as mobile handheld, network and communication)	WW Cutting Edge technology in focused technical areas (such as mobile handheld, network and communication, bT , C bud and B ig D ata etc.)
Packaging and Test	>30% revenue from Mid to High end application	WW Cutting Edge technology
Materials	12" Silicon Wafer mass production	Qualified in International IC manufacturing supply chain
Equipment	65~45nm Critical equipment in mass production	Qualified in International IC manufacturing supply chain

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Fastgrow th

• More than 20 semiconductor fabs in construction plan since 2016!

• Merge and Acquisitions – hunting world wide!

Challenge

- Technology barriers
- Lack of talents
- •Components, Materials, Basic Science...

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	3%	

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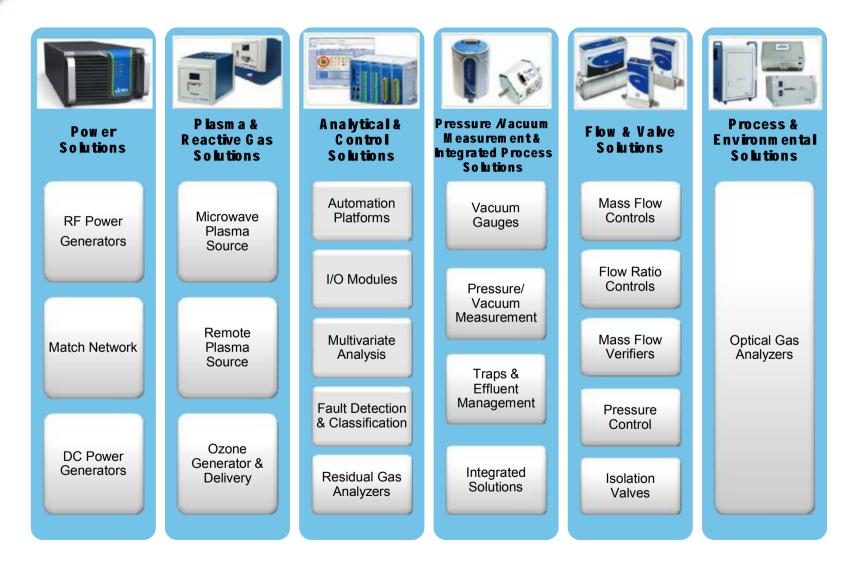




MKS Confidential 5

MKS Business Units

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Product Portfolio



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- Automation and Control
- D ata A na lytics
- Flow and Gas Delivery
- Gas Analyzers (Optical & MS)
- Custom EffluentManagement
- Lasers and LightSources
- LightAnalysis
- Microwave Systems
- Motion Control
- 0 p tics
- Plasm a Sources
- PowerSystems
- Pressure and Vacuum Instruments
- Reactive G as G enerators
- Vibration Isolation Tables & Systems
- Custom Vacuum Solutions
- Valves

Pressure and Vacuum Measurement Solutions

TRANSDUCERS & GAUGE CONTROLLERS



• 10⁻¹¹ to 1000 Torr • Pirani, Convection, Piezo Hot& cold cathode • MEMs based Pirani

PRESSURE MEASUREMENT SUBSYSTEMS



- Transducer, iso lation valve & controller
- Single-chamberconnection point
- S im p lifies pressure m an agem en t

Accuracy in harsh environments

• High res.dig ital output with

• Ranges from 0.02 π1000T

Temperatures to 200°C

analog equivalent

BARATRON® CAPACITANCE MANOMETERS



- **ISSUES IMPACTING** FABS
- Process control & yield
- Faster processes
- Higher temperatures
- Low er pressure
- Larger substrates
- Better control

SOLUTIONS FROM MKS

- **DIRECT & INDIRECT** GAUGES
- Higher temperatures
- Increased accuracy, precision & speed
- Low er pressure
- Embedded diagnostics
- RF immunity (digital comms)
- High reliability





MKS Flow Solutions

FLOW RATIO CONTROL



- Fast, accurate flow ratio control
- 2,3,& 4-zone solutions
- Wide dynam ic range
- Web-enabled diagnostics

PRESSURE CONTROL



Baratron Capacitance Manometer
1 Torr to 100 psia FullScale
Integral flow measurement option
Dual channel assembly for backside wafer cooling application

MASS FLOW CONTROL



 Multi-gas/multi-range capability
 5 sccm π1000 slm Full Scale
 Insensitive to pressure disturbances
 Pulsed gas /molar delivery options

FLOW VERIFICATION



- External volume insensitive
 - 0 ne device for multiple chambers
- Exceptional repeatability and reproducibility

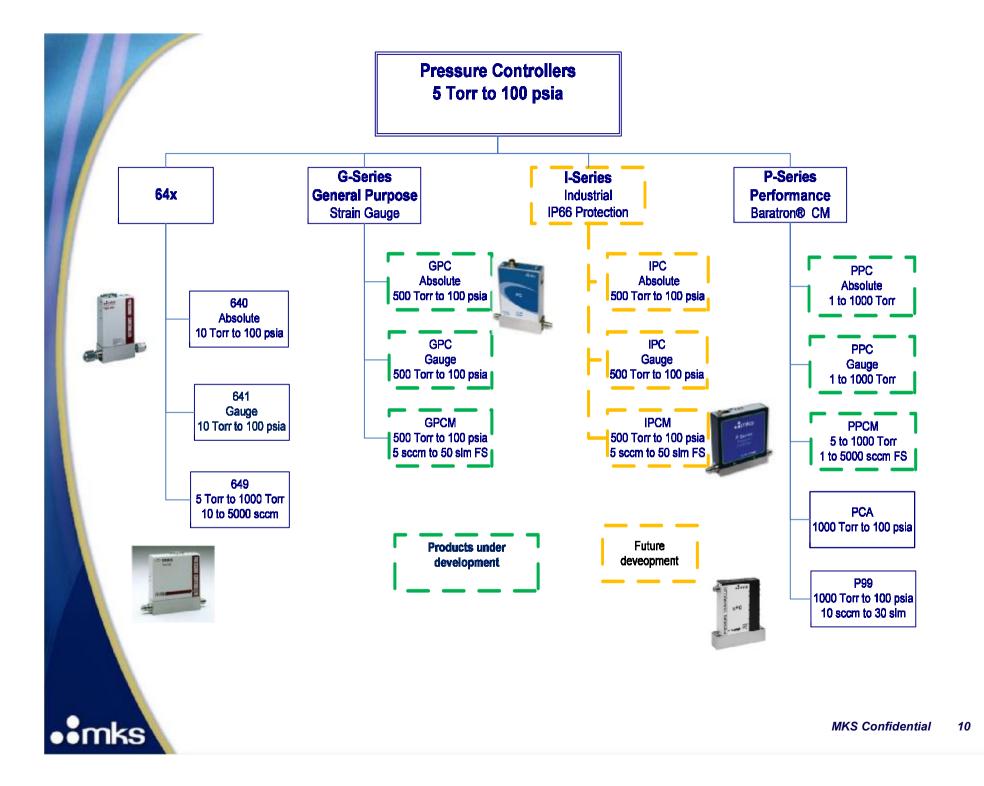
ISSUES IMPACTING CUSTOMERS

- Chamber Matching
- Process Uniformity
- Faster Processes
- ToolU tilization /Up time
- Diagnostics and Ease of Use

SOLUTIONS FROM MKS

FLOW CONTROL

- H igh Accuracy, repeatability & reproducibility
- Faster process control response
- High reliability
- Embedded user interface
- In-situ verification





Valve Solutions

Stain less steel & alum inum
Two stage with integrated soft pump
Heated & unheated
High cycle (10M + cycles)
Corrosion resistant



- High speed, high torque,
 <200 m sec open to close
 Heatable to 1500C
- Advanced model-based control
- Robust for processes with exhaust deposits

 Cost Effective Solution for Roughing Pump Isolation

- Soft Pump Bypass for reduced particle generation during pumpdow n
- Uniform Heating to prevent condensation of corrossives

ISSUES IMPACTING OEMs

- Process control & yield
- Faster processes
- Higher tem peratures
- Larger substrates
- Better control
- Preventative maintenance due to exhaust deposits

PRESSURE CONTROL

SOLUTIONS

FROM

MKS

- Higher tem peratures
- Increased accuracy & precision
- Extended PM intervals
- Better Control Performance
- Embedded diagnostics
- Digital communications
- High reliability

Integrated Process Solutions

VACUUM FITTINGS



- Fittings, flanges & components
 Stainless steel, alum inum , brass
- ISO -K F, ISO -U niversal, C F, welded
 State-of-the-art, complies with latest fab specifications

HEATED PUMP LINES



- Form fitting for tight control
 Self requilating (no external temp
- controller)
 Options for high temp fiber glass heaters up to 260°C
- FM certified

CUSTOM SOLUTIONS

- Process traps
- Nitrogen barrier devices to prevent byproduct build up
- Virtual wall to reduce particulates
- Complete turnkey vacuum foreline solutions

ISSUES IMPACTING FABS

- Tighter particle specs
- LowerC00
- Higheryields
- Higher throughput



- EFFLUENT MANAGEMENT USING HEATERS, VIRTUAL WALL, TRAPS
- Increase up time of tool
- Increase pum p lifetim e
- Reduce particulates
- Reduce energy consumption

MKS Solutions In Gas Analysis & Leak Detection

HIGH PRESSURE PUMP-FREE PROCESS RGAs



 Compact control module for limited space applications such as clean room areas
 Monitoring of degas, pre-clean, buffer & transfer chambers

VACUUM QUALITY MONITORING



System gas load analysis
Leak detection (real or virtual)
Analyse out-gassing issues
Differentiate different gas species
Compact, fast and easy-to-use

IN-SITU PROCESS MONITORING & LEAK DETECTION



Low ppb, trace level detection
Component process R G A
Fully integrated, application-specific packages
FAB-level so flw are so lutions

ATMOSPHERIC GAS ANALYSIS



Low ppb, travel level detection
Com pact, fast response
Characterization of simple and com plex mixtures
Multipoint calibration for guan

ISSUES IMPACTING FABs

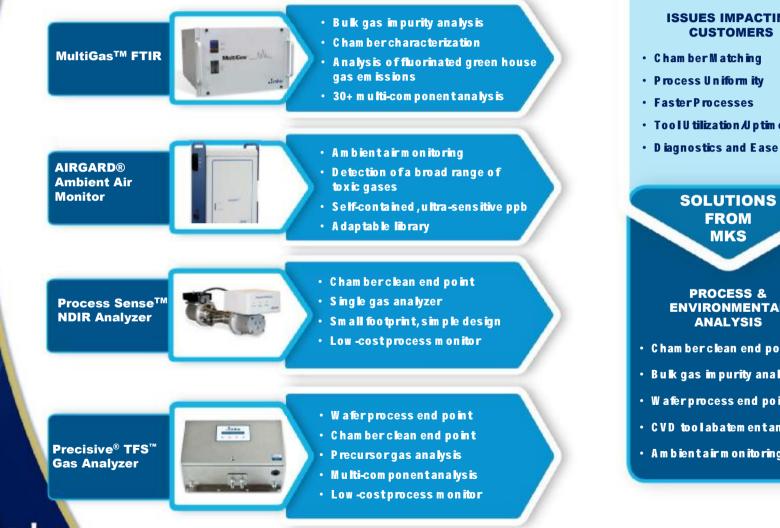
- Need to confirm vacuum quality and integrity
- Identify contamination which causes:
 - π Process variability
 - π increased PM s
 - π Reduced yield

SOLUTIONS FROM MKS

GAS ANALYSIS & LEAK DETECTION

- In situ m on ito ring
- Improved uptime
- Increased yield
- Protects tools from contam in ation
- Monitors vacuum quality
- Monitors for leaks

Process & Environmental Analysis (P&EA) Group Optical Gas Analysis



ISSUES IMPACTING CUSTOMERS

- ChamberMatching
- Process Uniformity
- ToolUtilization/Uptime
- Diagnostics and Ease of Use

PROCESS & ENVIRONMENTAL

- Chamberclean end point
- Bulk gas impurity analysis
- Wafer process end point
- CVD tool abatement analysis
- Ambientairmonitoring

MKS Solutions In RF Power

13.56 MHz RF PULSED POWER



Multiple setpoint Closed loop pulse shaping control

Industry leading pulsing

- Dynamic Frequency tuning
- Integrated Visensor
- On-board diagnostics



- Multiple setpoint Closed loop pulse shaping
- Integrated Visensor
- Power accuracy & digital control for fast response

RF MATCH

- Fully digital controlled system • Fast, converging algorithms
- Automatic, manual & preset modes
- A djustable matching trajectories

ISSUES IMPACTING FABS

- High aspect ratio etch
- Sidew all roughness
- Reflected power
- Cleaning and surface preparation
- Process repeatability

MKS SOLUTIONS PROVIDE

- Quick impedance adaptation for etching through different material layers
- 50 Esec dynam ic frequency tuning m in im izing reflected power
- Consistenthigh output pow er de livery
- Power accuracy of < K1.0% setpoint

Power Solutions EDGE Platform

- New MKS Branding
 - 400KHz to 60MHz
- Common Modules
- Scalable & Fast Product Development
 - 30% Faster
 - Multiple Frequencies & Power Levels
- Leading Technology



Solutions In Remote Plasmas & Reactive Gas

OZONE GENERATORS & DELIVERY SYSTEMS



Gas & dissolved ozone
High flow, purity & concentration
ALD, CVD, cleaning, prep, oxide grow th
Recirculation of ozonated water

ON-WAFER PLASMA PROCESS



- Remote plasm a wafer processing
 Significantly reduces overall investment & tool operating costs
- Photores is trem oval, wafer
 pre-clean, nitridation, oxidization

CHAMBER Clean

- Remote plasm a chamber clean
 High reactive species output, self-contained unit
- High power& highergas flows enable reduced clean times

ISSUES IMPACTING OEMs

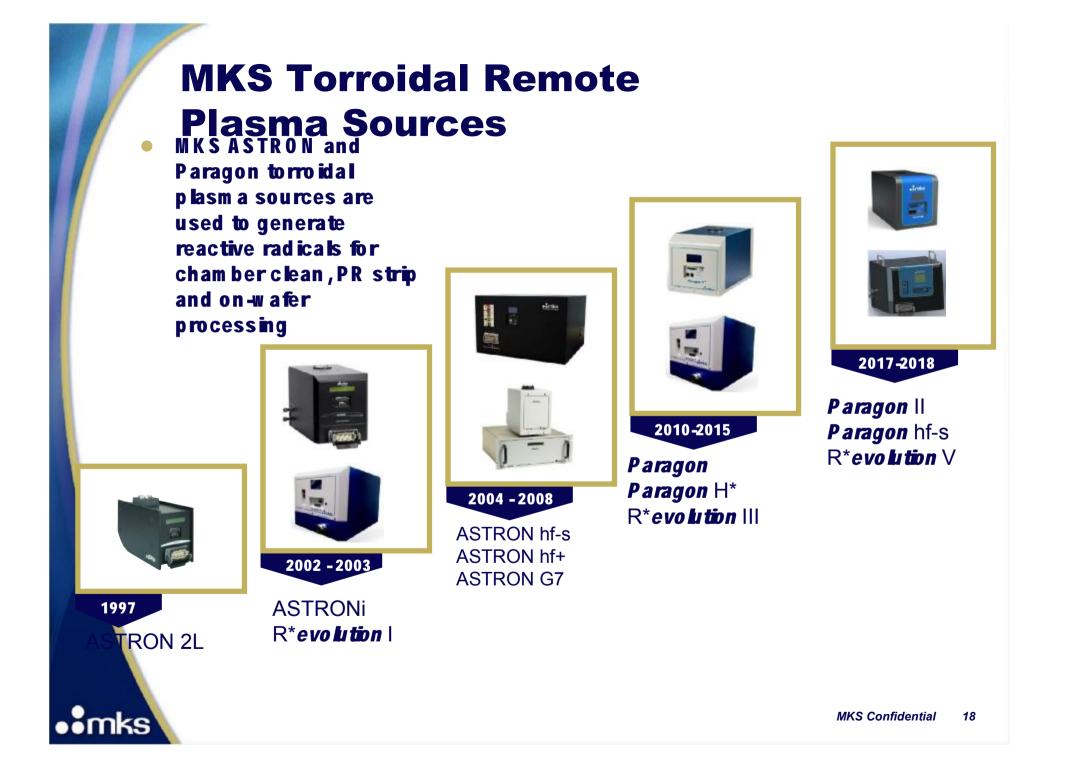
- New materials & processes
- Tighter process control
- Larger substrates
- Short process times
- Contam ination
- Cost: w ater, pow er & chem ical consumption

SOLUTIONS FROM MKS

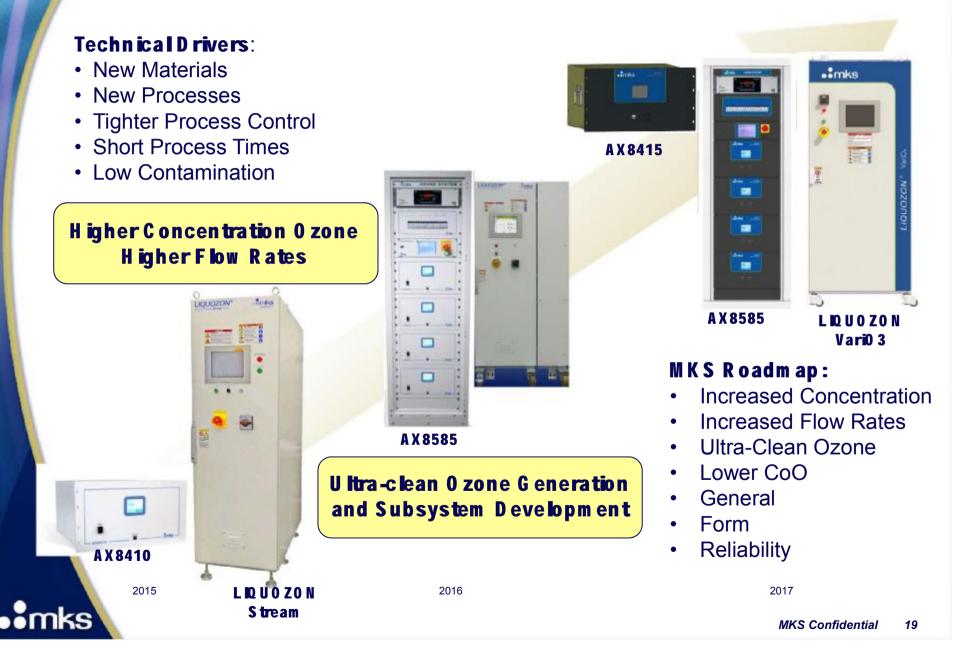
ATOMIC SPECIES & REACTIVE GAS FOR PROCESSING & CLEANING

- Precise
- Clean
- Reliable
- Costeffective
- Environmentally friendly





Product Roadmap - OZONE Products



MKS Automation & Control Solutions

INTELLIGENT & PROGRAMMABLE AUTOMATION PLATFORMS



- C -program m able, L in ux logic controllers.
- in tegrated and modular PLCs and PACs .
- Control templates and plug -ins for sem iconductor fab instrumentation

EtherCAT ,ETHERNET, DEVICENET & PROFIBUS I/O DEVICES



Analog, digital & combomodules for common instrumentation
Quick connect module configurations
Turn skey signal distribution and packages
Configurations include 2 to 2000 ID

SYSTEM Control Solutions



- Precision temperature controller
- MVA based control packages
 Safety system

po in ts

COMPACT PCI CARDS & CAGES



- Unique, rear 1/0 & communication cards
 Power supply cards
- 3U developmentkit

ISSUES IMPACTING FABS

- Precision processing requires better control, repeatability & reliability
- Cham ber m atching requires tight synchronization between subsystems
- More devices to control
- Higher data volum e

SOLUTIONS FROM MKS

AUTOMATION PLATFORM AND TOOLS

- Enables precise control and superior process repeatability.
- Extended product lifecycle to match capital equipment time line
- Lowercost
- Faster time to market than in house design

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G lobal Presence Supports of Technical Localization τ Strategy





In Closing

Strong Supplier

Recognized leader

- Market leader with broad technology portfolio
- Supporting Sem i industry for >50 years

Financially stable

Investing in technology & development Critical, Enabling Technologies

Proven technology for leading edge processes enabling technology infections

Core capabilities

- Precise control of pressure, flow and composition
- Generation and delivery of power & reactive gases
- Integrated solutions for process modules & systems
- Precise control of position, motion and stability
- Generation & delivery of laser power
- Integrated solutions for inspection & lithography modules & systems

Global Presence

G lobal footprint

Local supportπ Chinaπ Franceπ Japanπ Germ anyπ Singaporeπ Koreaπ Israelπ Taiw anπ UKπ USA